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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









**AP3772H** 

#### **General Description**

The AP3772H is a high performance AC/DC power supply controller for battery charger and adapter applications. The device uses Pulse Frequency Modulation (PFM) method to build discontinuous conduction mode (DCM) flyback power supplies.

The AP3772H provides accurate constant voltage, constant current (CV/CC) regulation without requiring an opto-coupler and the secondary control circuitry. It also eliminates the need of loop compensation circuitry while maintaining good stability. The AP3772H can achieve excellent regulation and high average efficiency, yet meets no-load consumption less than 30mW. It can also achieve excellent dynamic performance while maintaining 30mW standby power with AP4340.

The AP3772H has a built-in fixed cable voltage drop compensation function. The magnitude of the cable compensation voltage is set as 3% of the rated output voltage. It also has an adjustable built-in line compensation function to achieve tight CC.

The AP3772H is available in SOT-23-6 package.

#### **Features**

- Primary Side Control for Tight Constant Current and Constant Voltage
- 30mW No-load Input Power
- Excellent Dynamic Performance with AP4340
- Bipolar Junction Transistor (BJT) Driving
- Proprietary Adjustable Line Compensation for CC Variation
- Constant and Built-in 6%, 3% and No Cable Voltage Drop Compensation
- Enhanced Audio Noise Suppression
- Open Circuit Protection
- Over Voltage Protection
- Short Circuit Protection
- SOT-23-6 package

#### **Applications**

- Adapters/Chargers for Cell/cordless Phones, PDAs, MP3 and Other Portable Devices
- LED Driver
- Standby and Auxiliary Power Supplies

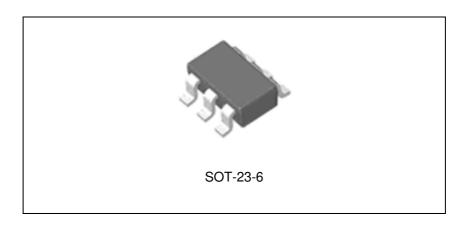


Figure 1. Package Type of AP3772H



**AP3772H** 

# **Pin Configuration**

K6 Package (SOT-23-6)

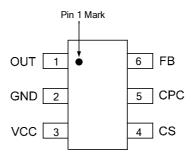


Figure 2. Pin Configuration of AP3772H (Top View)

# **Pin Description**

Pin Number	Pin Name	Function		
1	OUT	The OUT pin is used to turn on and turn off the power switch. When turning on the power switch, the OUT pin will output 30mA source current to support the base current of the power BJT. When turning off the power switch, the resistance between the OUT and GND will become to $5\Omega$		
2	GND	The GND pin is the ground of the IC. When the power BJT is turned off, a fast reverse sinking current to the gate of BJT will flow out from this pin. Attention should be paid to in the PCB layout		
3	VCC	The VCC pin supplies the power for the IC. In order to get the correct operation of the IC, a capacitor with low ESR should be placed as close as possible to the VCC pin		
4	CS	The CS is the current sense pin of the IC. The IC will turn off the power BJT according to the voltage on the CS pin. When the power BJT is on, a current is output from the CS pin which is proportional to the line voltage to realize the function of line compensation		
5	СРС	A capacitor more than 10nF should be connected to this pin. The voltage of CPC pin is linear to load of the system and it is used for the functions of cable voltage drop compensation and audio noise suppression		
6	FB	The CV and CC regulation are realized based on the voltage sampling of this pin		



**AP3772H** 

## **Functional Block Diagram**

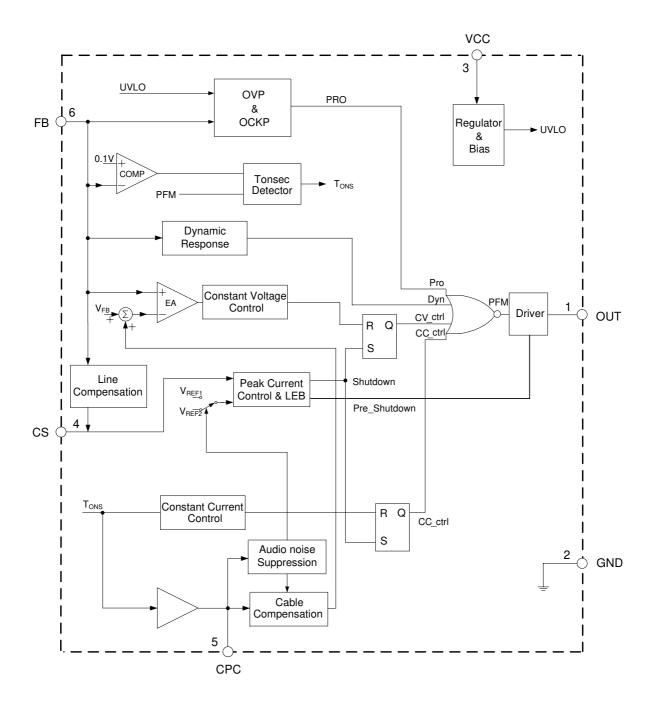
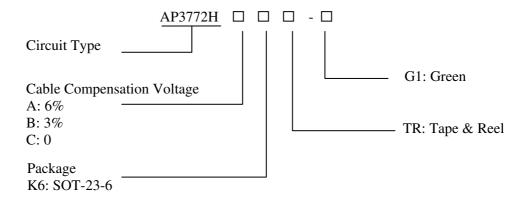


Figure 3. Functional Block Diagram of AP3772H



**AP3772H** 

### **Ordering Information**



Package	Temperature Range	Cable Compensation Voltage	Part Number	Marking ID	Packing Type
SOT-23-6	-40 to 85°C	6%	AP3772HAK6TR-G1	GBC	Tape & Reel
		3%	AP3772HBK6TR-G1	GKJ	Tape & Reel
		0	AP3772HCK6TR-G1	GJD	Tape & Reel

BCD Semiconductor's Pb-free products, as designated with "G1" suffix in the part number, are RoHS compliant and green.

## **Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Value	Unit	
Supply Voltage	$V_{CC}$	-0.3 to 30	V	
CS, CPC to GND		-0.3 to 7	V	
FB Input Voltage	$ m V_{FB}$	-40 to 10	V	
Source Current at OUT Pin	I <sub>SOURCE</sub>	Internally Limited	A	
Operating Junction Temperature	$T_{J}$	150	°C	
Storage Temperature	$T_{STG}$	-65 to 150	°C	
Lead Temperature (Soldering, 10 sec)	$T_{LEAD}$	300	°C	
Thermal Resistance (Junction to Ambient)	$\theta_{\mathrm{JA}}$	200	°C/W	

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.



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### **Electrical Characteristics**

 $V_{CC}$ =15V,  $T_A$ =25°C, unless otherwise specified.

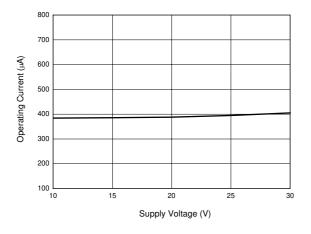
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
UVLO SECTION							
Startup Threshold		V <sub>TH</sub> (ST)		13	15.5	18	V
Minimal Operating	Voltage	V <sub>OPR</sub> (MIN)		3	3.5	4.5	V
STANDBY CURF	RENT SEC	TION					
Startup Current		$I_{ST}$	V <sub>CC</sub> =V <sub>TH</sub> (ST)-1V, Before startup	0	0.2	0.6	μΑ
Operating Current		$I_{CC}(OPR)$	Static current	250	500	600	μΑ
DRIVE OUTPUT	DRIVE OUTPUT SECTION						
Output Current	Sink	$I_{SINK}$	Apply 1V @ OUT pin	150	330	500	mA
Output Current	Source	$I_{SOURCE}$		30	40	50	mA
Maximum Off Tim	ie	$t_{OFF}(MAX)$		14	18	25	ms
CURRENT SENS	E SECTIO	)N					
Current Sense Threshold Voltage at Heavy Load		$V_{CS1}$		500	525	550	mV
Leading Edge Blanking		$t_{\rm LEB}$	The minimum power switch turn on time	300	500	650	ns
FEEDBACK INP	UT SECTI	ON					
Input Resistance of	f FB Pin	$R_{FB}$	V <sub>FB</sub> =4V	1	1.6	2	$M\Omega$
Feedback Threshol	d	$V_{FB}$		3.98	4.04	4.1	V
LINE COMPENS	SATION SI	ECTION					
Line Compensation Transconductance (Note 2)		$g_{\rm m}$		0.8	1.2	1.6	μS
CABLE COMPE	NSATION	SECTION					
Cable Compensation Voltage		ation $\Delta V_{FB\_CABLE}$ / $V_{FB}$ %	AP3772HA	5	6	7	%
			AP3772HB	2	3	4	
			AP3772HC		0		
DYNAMIC FUNC	CTION SE	CTION					
Delay Time for Function	Dynamic	$t_{\mathrm{D}}$		110	150	200	μs
Trigger Voltage for Dynamic Function		V <sub>TRIGGER</sub>		120	150	180	mV
PROTECTION S	ECTION						
Over Voltage Protection		V <sub>FB</sub> (OVP)		7	8	9	V
Maximum On Time of Primary Side		tonp (MAX)		20	35	50	μs

Note 2: Line compensation voltage on CS pin:  $\Delta V_{CS} = V_{IN\_DC} \cdot \frac{N_{AUX}}{N_{PRI}} \cdot \frac{R_6}{R_6 + R_7} \cdot g_{_{m}} \cdot R_{LINE}$ 



**AP3772H** 

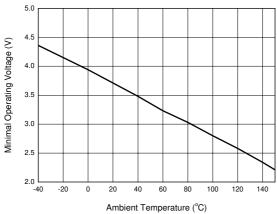
# **Typical Performance Characteristics**



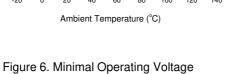
40

Figure 4. Operating Current vs. Supply Voltage

Figure 5. Source Current vs. Supply Voltage



vs. Ambient Temperature



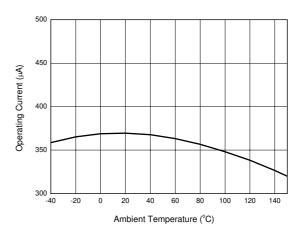
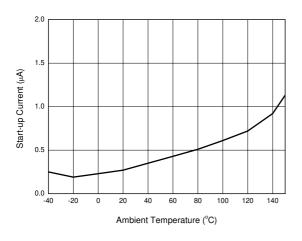


Figure 7. Operating Current vs. Ambient Temperature



**AP3772H** 

## **Typical Performance Characteristics (Continued)**



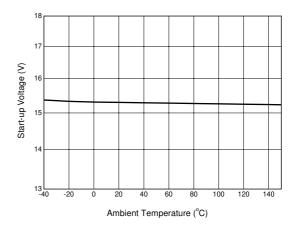
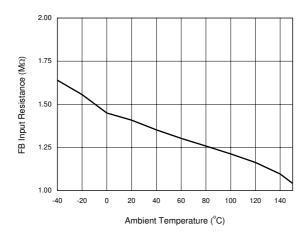


Figure 8. Start-up Current vs. Ambient Temperature

Figure 9. Start-up Voltage vs. Ambient Temperature



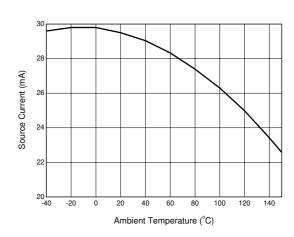


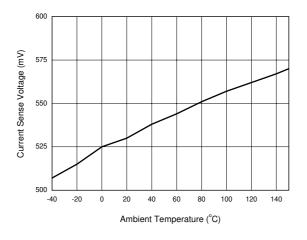
Figure 10. FB Input Resistance vs. Ambient Temperature

Figure 11. Source Current vs. Ambient Temperature



**AP3772H** 

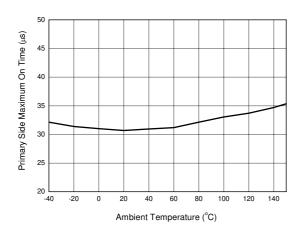
## **Typical Performance Characteristics (Continued)**



155 (st) 0 140 -20 -10 0 10 20 30 40 50 60 70 80 Ambient Temperature (°C)

Figure 12. Current Sense Voltage vs. Ambient Temperature

Figure 13. Delay Time vs. Ambient Temperature



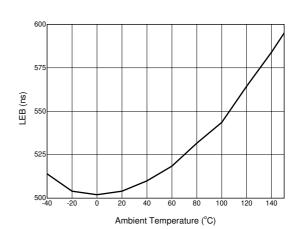


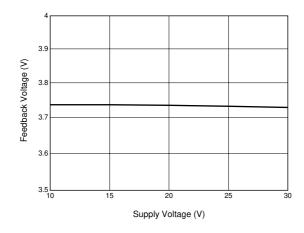
Figure 14. Primary Side Maximum On Time vs. Ambient Temperature

Figure 15. LEB vs. Ambient Temperature



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# **Typical Performance Characteristics (Continued)**



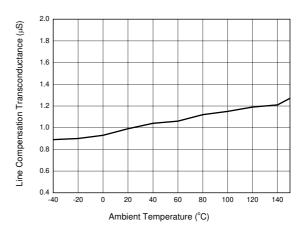


Figure 16. Feedback Voltage vs. Supply Voltage

Figure 17. Line Compensation Transconductance vs. Ambient Temperature



**AP3772H** 

# **Typical Application**

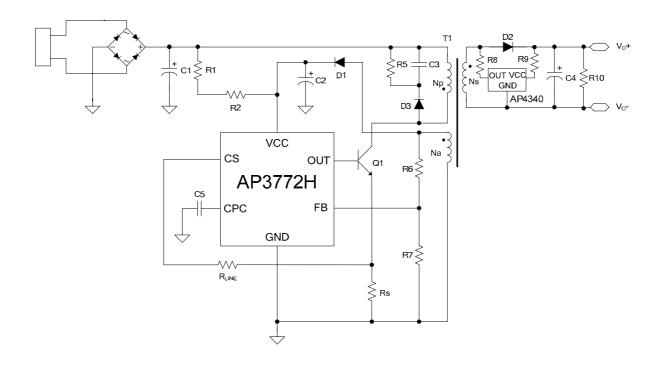


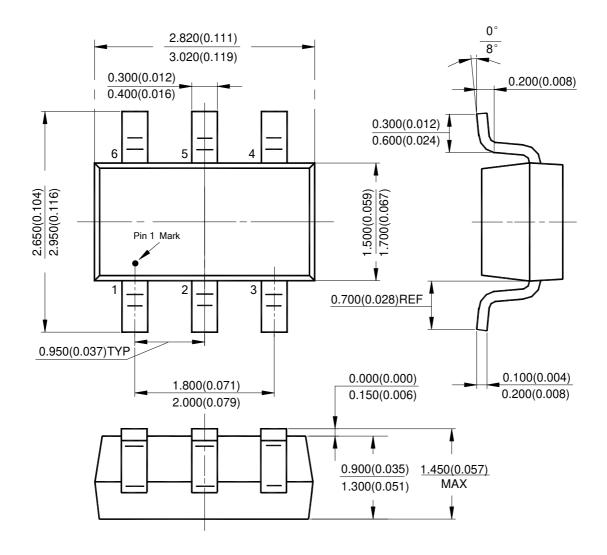
Figure 18. 5V/1A Output for Battery Charger of Mobile Phone (The AP4340 Is Used to Achieve Fast Dynamic Response)



**AP3772H** 

### **Mechanical Dimensions**

SOT-23-6 Unit: mm(inch)







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#### MAIN SITE

- Headquarter

BCD (Shanghai) Micro-electronics Limited

No. 1600, Zi Xing Road, Shanghai ZiZhu Science-based Industrial Park, 200241, P. R.C. Tel: +86-021-2416-2266, Fax: +86-021-2416-2277

#### REGIONAL SALES OFFICE

Shenzhen Office

Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd., Shenzhen Office Unit A Room 1203,Skyworth Bldg., Gaoxin Ave.1.S., Nanshan District Shenzhen 518057, China

Tel: +86-0755-8660-4900 Fax: +86-0755-8660-4958

Taiwan Office (Hsinchu) BCD Semiconductor (Taiwan) Company Limited 8F, No.176, Sec. 2, Gong-Dao 5th Road, East District HsinChu City 300, Taiwan, R.O.C Tel: +886-3-5160181, Fax: +886-3-5160181

- Wafer Fab

Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd.

800 Yishan Road, Shanghai 200233, China Tel: +021-6485-1491, Fax: +86-021-5450-0008

Taiwan Office (Taipei)

BCD Semiconductor (Taiwan) Company Limited 3F, No.17, Lane 171, Sec. 2, Jiu-Zong Rd., Nei-Hu Dist., Taipei(114), Taiwan, R.O.C Tel: +886-2-2656 2808

Fax: +886-2-2656-2806/26562950

BCD Semiconductor Corp. 48460 Kato Road, Fremont, CA 94538, USA Tel: +1-510-668-1950 Fax: +1-510-668-1990

BCD Semiconductor Limited Korea office. Room 101-1112, Digital-Empire II, 486 Sin-dong, Yeongtong-Gu, Suwon-city, Gyeonggi-do, Korea Tel: +82-31-695-8430